

MOSFET

OptiMOS[™] 5 Power-Transistor, 80 V

Features

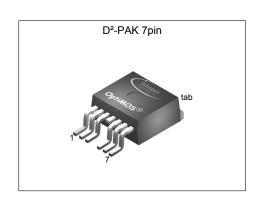
- Ideal for high frequency switching and sync. rec.
 Optimized technology for DC/DC converters
 Excellent gate charge x R_{DS(on)} product (FOM)
 Very low on-resistance R_{DS(on)}

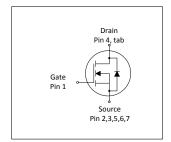
- N-channel, normal level

- 100% avalanche tested
 Pb-free plating; RoHS compliant
 Qualified according to JEDEC¹⁾ for target applications
 Halogen-free according to IEC61249-2-21



Parameter	Value	Unit
$V_{ extsf{DS}}$	80	V
R _{DS(on),max}	1.5	mΩ
I _D	260	A
Q _{oss}	207	nC
Q _G (0V10V)	178	nC











Type / Ordering Code	Package	Marking	Related Links
IPB015N08N5	PG-TO263-7	015N08N5	-

OptiMOS[™] 5 Power-Transistor, 80 V



Table of Contents

Description	1
Maximum ratings	3
Thermal characteristics	3
Electrical characteristics	4
Electrical characteristics diagrams	6
Package Outlines	0
Revision History	1
Trademarks 1	1
Disclaimer	1

OptiMOS[™] 5 Power-Transistor, 80 V IPB015N08N5



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

Developed	Cymphol	Values			11	Nata / Tank Oans Hittan	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current	I _D	-	-	260 199	А	V _{GS} =10 V, T _C =25 °C ¹⁾ V _{GS} =10 V, T _C =100 °C	
Pulsed drain current ²⁾	I _{D,pulse}	-	-	1040	Α	T _C =25 °C	
Avalanche energy, single pulse ³⁾	E _{AS}	-	-	1230	mJ	$I_{\rm D}$ =100 A, $R_{\rm GS}$ =25 Ω	
Gate source voltage	V _{GS}	-20	-	20	V	-	
Power dissipation	P _{tot}	-	-	375	W	T _C =25 °C	
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	IEC climatic category; DIN IEC 68-1: 55/175/56	

2 Thermal characteristics

Table 3 Thermal characteristics

Dougnator	Cumbal	Values			11	Nata / Taat Canditian	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case	R _{thJC}	-	0.3	0.4	K/W	-	
Thermal resistance, junction - ambient, minimal footprint	R _{thJA}	-	-	62	K/W	-	
Thermal resistance, junction - ambient, 6 cm² cooling area ⁴⁾	R _{thJA}	-	-	40	K/W	-	
Soldering temperature and reflow soldering is allowed	T _{sold}	-	-	260	°C	Reflow MSL1	

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.
2) See Diagram 3 for more detailed information

³⁾ See Diagram 13 for more detailed information

⁴⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

OptiMOS[™] 5 Power-Transistor, 80 V IPB015N08N5



3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Danamatan	Ob o.l		Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	80	-	-	V	V _{GS} =0 V, I _D =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	2.2	3	3.8	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 279 \ \mu {\rm A}$	
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μΑ	V _{DS} =80 V, V _{GS} =0 V, T _j =25 °C V _{DS} =80 V, V _{GS} =0 V, T _j =125 °C	
Gate-source leakage current	I _{GSS}	-	1	100	nA	V _{GS} =20 V, V _{DS} =0 V	
Drain-source on-state resistance	R _{DS(on)}	-	1.1 1.5	1.5 1.8	mΩ	V _{GS} =10 V, I _D =100 A V _{GS} =6 V, I _D =50 A	
Gate resistance 1)	R _G	-	1.5	2.3	Ω	-	
Transconductance	g _{fs}	123	245	-	S	$ V_{DS} > 2 I_D R_{DS(on)max}, I_D = 100 A$	

Dynamic characteristics¹⁾ Table 5

Developer	Or made at	Values			11	Nata / Tank Oam Hittan	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance	Ciss	-	13000	16900	pF	V _{GS} =0 V, V _{DS} =40 V, f=1 MHz	
Output capacitance	Coss	-	2000	2600	pF	V _{GS} =0 V, V _{DS} =40 V, f=1 MHz	
Reverse transfer capacitance	C _{rss}	-	86	150	pF	V _{GS} =0 V, V _{DS} =40 V, f=1 MHz	
Turn-on delay time	t _{d(on)}	-	33	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω	
Rise time	t _r	-	32	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω	
Turn-off delay time	$t_{\sf d(off)}$	-	83	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω	
Fall time	t _f	-	28	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω	

Gate charge characteristics²⁾ Table 6

Davamatar	Cymbal	Values			11	Nata / Tast Canditian	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Gate to source charge	Q _{gs}	-	56	-	nC	V_{DD} =40 V, I_{D} =100 A, V_{GS} =0 to 10 V	
Gate to drain charge ¹⁾	$Q_{ m gd}$	-	37	56	nC	V_{DD} =40 V, I_{D} =100 A, V_{GS} =0 to 10 V	
Switching charge	Q _{sw}	-	58	-	nC	V_{DD} =40 V, I_{D} =100 A, V_{GS} =0 to 10 V	
Gate charge total ¹⁾	Q g	-	178	222	nC	V_{DD} =40 V, I_{D} =100 A, V_{GS} =0 to 10 V	
Gate plateau voltage	V _{plateau}	-	4.5	-	V	V_{DD} =40 V, I_{D} =100 A, V_{GS} =0 to 10 V	
Gate charge total, sync. FET	Q _{g(sync)}	-	153	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V	
Output charge ¹⁾	Qoss	-	207	276	nC	V _{DD} =40 V, V _{GS} =0 V	

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

OptiMOS[™] 5 Power-Transistor, 80 V

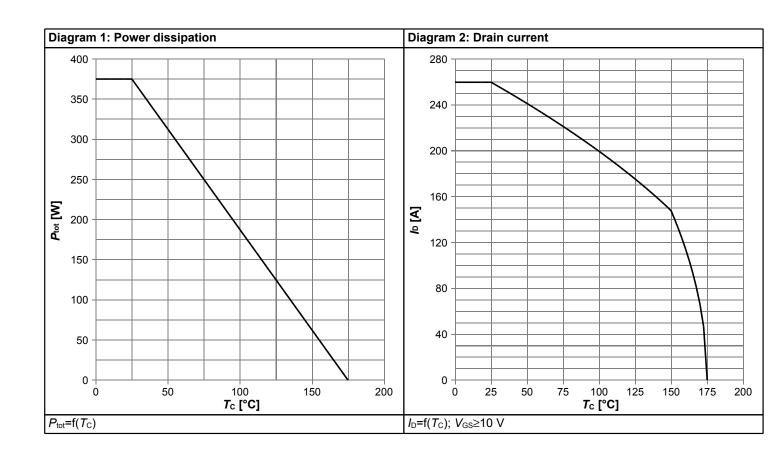


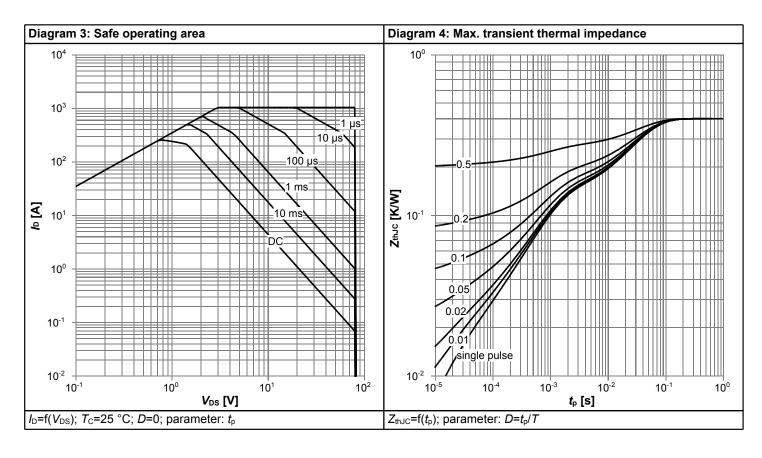
Table 7 Reverse diode

Davamatar	Complete	Values			11:4	Nata / Taat Canditian	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continous forward current	Is	-	-	202	Α	T _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	1040	Α	T _C =25 °C	
Diode forward voltage	V _{SD}	-	0.86	1.2	V	V _{GS} =0 V, I _F =100 A, T _j =25 °C	
Reverse recovery time ¹⁾	t _{rr}	-	94	188	ns	V _R =40 V, I _F =100 A, d <i>i</i> _F /d <i>t</i> =100 A/μs	
Reverse recovery charge ¹⁾	Qrr	-	246	492	nC	V _R =40 V, I _F =100 A, d <i>i</i> _F /d <i>t</i> =100 A/μs	

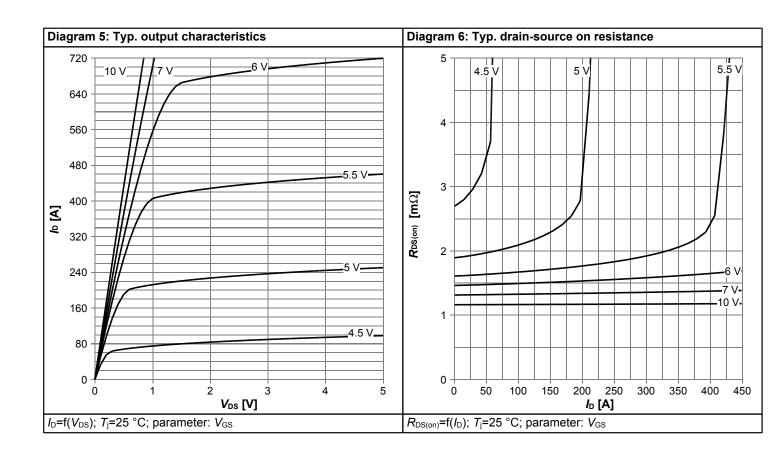


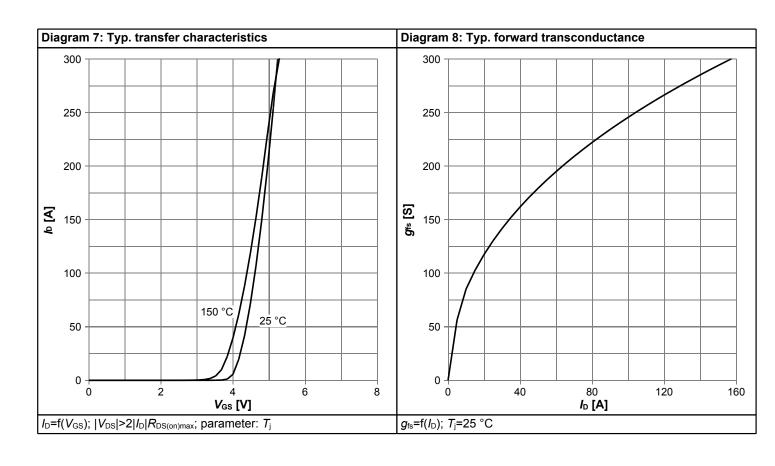
4 Electrical characteristics diagrams



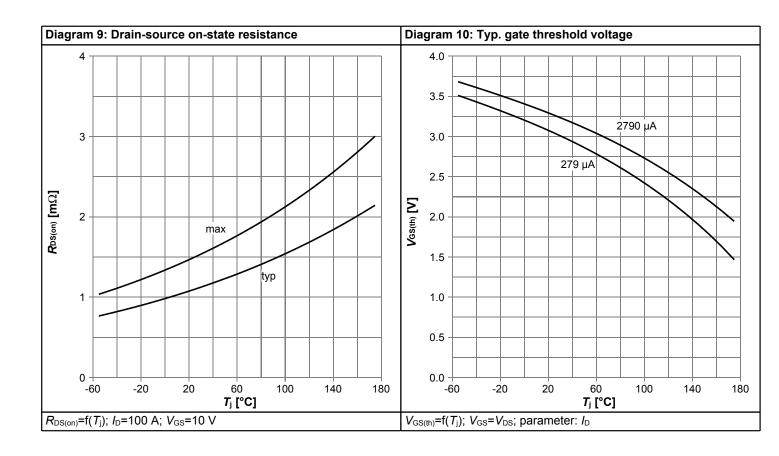


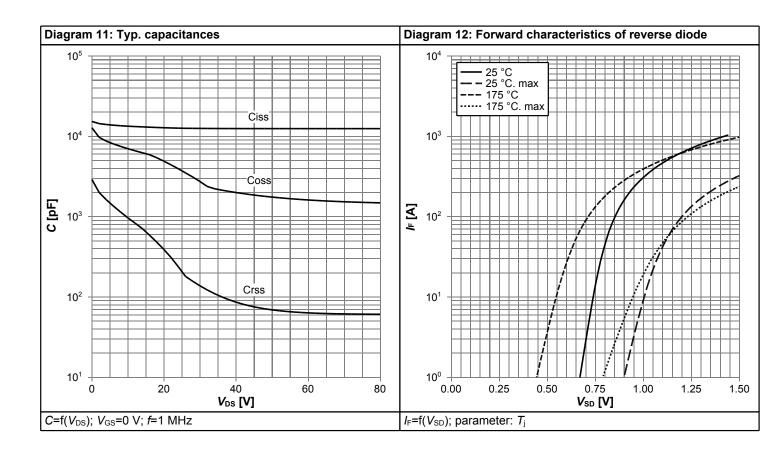




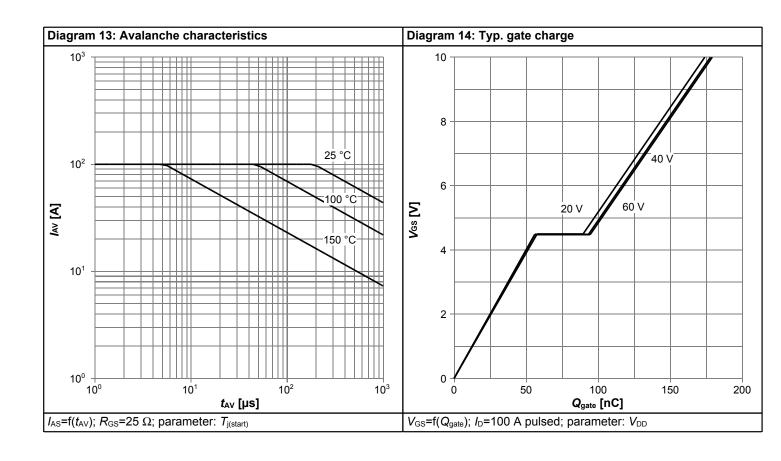


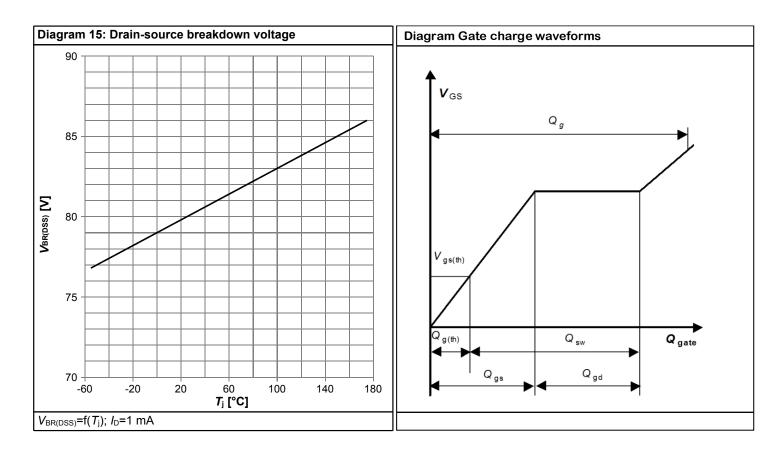






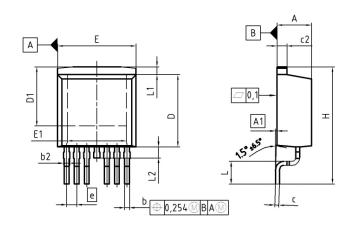


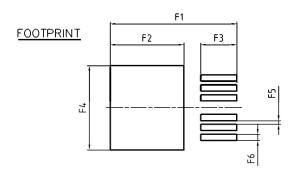






5 Package Outlines





DIM	MILLIM	IETERS	INC	HES		
DIM	MIN	MAX	MIN	MAX		
Α	4.30	4.57	0.169	0.180		
A1	0.00	0.25	0.000	0.010		
Ь	0.50	0.70	0.020	0.028		
b2	0.50	1.00	0.020	0.039		
С	0.33	0.65	0.013	0.026		
c2	1.17	1.40	0.046	0.055		
D	8.51	9.45	0.335	0.372		
D1	6.90	7.90	0.272	0.311		
E	9.80	10.31	0.386	0.406		
E1	6.50	8.60	0.256	0.339		
е	1.	27	0.050			
N		6		6		
Н	14.61	15.88	0.575	0.625		
L	2.29	3.00	0.090	0.118		
L1	0.70	1.60	0.028	0.063		
L2	1.00	1.78	0.039	0.070		
F1	16.05	16.25	0.632	0.640		
F2	9,30	9.50	0.366	0.374		
F3	4.50	4.70	0.177	0.185		
F4	10.70	10.90	0.421	0.429		
F5	0.37	0.57	0.015	0.022		
F6	0.70	0.90	0.028	0.035		

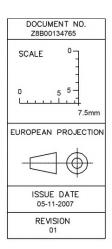


Figure 1 Outline PG-TO263-7, dimensions in mm/inches

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Revision History

IPB015N08N5

Revision: 2020-11-16, Rev. 2.2

Previous Revision

Revision	Date	Subjects (major changes since last revision)				
2.0	2014-12-11	Release of final version				
2.1	2015-10-15	Update package Outline				
2.2	2020-11-16	Update Max Id Current Rating				

Trademarks

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